AUTOMOTIVE GRADE

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HALOGEN

FREE



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## Vishay General Semiconductor

# High Current Density Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier

Ultra Low  $V_F = 0.56 \text{ V}$  at  $I_F = 2.5 \text{ A}$ 



#### **DESIGN SUPPORT TOOLS AVAILABLE**



PRIMARY CHARACTERISTICS				
I <sub>F(AV)</sub>	2 x 5 A			
V <sub>RRM</sub>	150 V			
I <sub>FSM</sub>	100 A			
$V_F$ at $I_F = 5$ A ( $T_A = 125$ °C)	0.63 V			
T <sub>J</sub> max.	150 °C			
Package	FlatPAK 5 x 6			
Circuit configuration	Common cathode			

#### **FEATURES**

- Trench MOS Schottky technology
- · Low forward voltage drop, low power losses
- · High efficiency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C



- Automotive ordering code: base P/NHM3
- Material categorization: for definitions of compliance please see <a href="https://www.vishav.com/doc?99912">www.vishav.com/doc?99912</a>

#### **TYPICAL APPLICATIONS**

For use in low voltage high frequency DC/DC converters, freewheeling diodes, and polarity protection applications.

#### **MECHANICAL DATA**

Case: FlatPAK 5 x 6

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant

Base P/NHM3 - halogen-free, RoHS-compliant, and

AEC-Q101 qualified

Terminals: matte tin plated leads, solderable per

J-STD-002 and JESD 22-B102

M3 and HM3 suffix meets JESD 201 class 2 whisker test

MAXIMUM RATINGS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	V10K150C	UNIT		
Device marking code		V1015C			
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	150	V		
Maximum DC forward ourrent per device	I <sub>F(AV)</sub> (1)	10	Α		
Maximum DC forward current per device	I <sub>F(AV)</sub> (2)	3	Α		
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load per diode	I <sub>FSM</sub>	100	А		
Operating junction temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +150	°C		
Storage temperature range	T <sub>STG</sub>	-55 to +150	°C		

#### **Notes**

- (1) With infinite heatsink
- (2) Free air, mounted on recommended pad area
- $^{(3)}$  The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$



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<b>ELECTRICAL CHARACTERISTICS</b> (T <sub>A</sub> = 25 °C unless otherwise noted)						
PARAMETER	TEST CONDITIONS		SYMBOL	TYP.	MAX.	UNIT
	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 25 °C	V <sub>F</sub> <sup>(1)</sup>	0.74	-	V
Instantance is femiliard voltage new diede	I <sub>F</sub> = 5 A			1	1.08	
Instantaneous forward voltage per diode	I <sub>F</sub> = 2.5 A	T <sub>A</sub> = 125 °C	VF \''	0.56	-	
	I <sub>F</sub> = 5 A			0.63	0.71	
	V <sub>R</sub> = 100 V	T <sub>A</sub> = 25 °C	I <sub>R</sub> <sup>(2)</sup>	0.01	-	- mA
Deverse suggest per diede		T <sub>A</sub> = 125 °C		1.5	-	
Reverse current per diode	V <sub>R</sub> = 150 V	T <sub>A</sub> = 25 °C		-	0.2	
		T <sub>A</sub> = 125 °C		3	8	
Typical junction capacitance per diode	4.0 V, 1 MHz		CJ	400	-	pF

#### **Notes**

(1) Pulse test: 300 µs pulse width, 1 % duty cycle

(2) Pulse test: pulse width  $\leq 5$  ms

THERMAL CHARACTERISTICS (T <sub>A</sub> = 25 °C unless otherwise noted)					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Thermal registance per device	R <sub>0</sub> JA (1)(2)	75	-	- °C/W	
Thermal resistance per device	R <sub>0JM</sub> (3)	2.5	3.5		

#### Notes

- $^{(1)}$  The heat generated must be less than thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{\theta JA}$
- $^{(2)}$  Free air, mounted on recommended copper pad area; thermal resistance  $R_{\theta JA}$  junction-to-ambient
- $^{(3)}$  Mounted on infinite heat sink; thermal resistance  $R_{\theta JM}$  junction-to-mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V10K150C-M3/H	0.10	Н	1500	7" diameter plastic tape and reel		
V10K150C-M3/I	0.10	I	6000	13" diameter plastic tape and reel		
V10K150CHM3/H (1)	0.10	Н	1500	7" diameter plastic tape and reel		
V10K150CHM3/I (1)	0.10	I	6000	13" diameter plastic tape and reel		

#### Note

(1) AEC-Q101 qualified



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## RATINGS AND CHARACTERISTICS CURVES (T<sub>A</sub> = 25 °C unless otherwise noted)

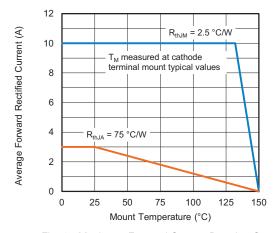


Fig. 1 - Maximum Forward Current Derating Curve

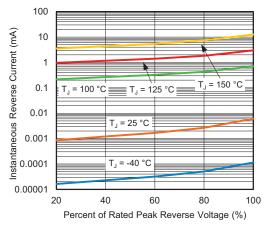


Fig. 4 - Typical Reverse Leakage Characteristics

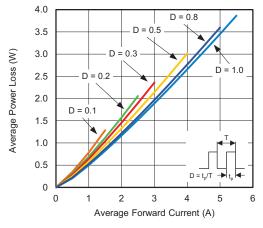


Fig. 2 - Forward Power Loss Characteristics

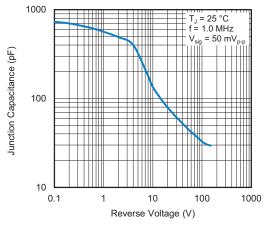


Fig. 5 - Typical Junction Capacitance

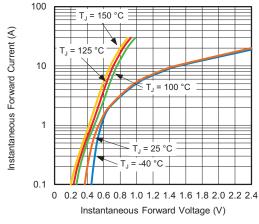


Fig. 3 - Typical Instantaneous Forward Characteristics

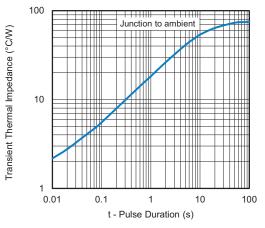


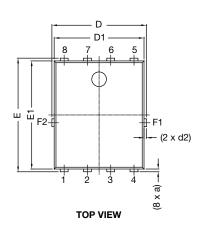
Fig. 6 - Typical Transient Thermal Impedance

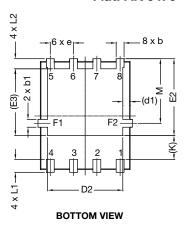


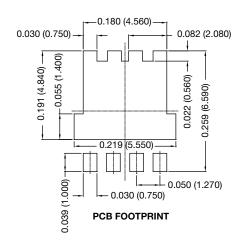
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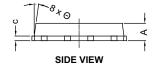
### **PACKAGE OUTLINE DIMENSIONS** in inches (millimeters)

#### FlatPAK 5 x 6









B.114		INCHES			MILLIMETERS	
DIM.	MIN.	NOM.	MAX.	MIN.	NOM.	MAX.
Α	0.035	0.039	0.043	0.89	0.99	1.09
(a)	-	0.006	-	-	0.15	-
b	0.013	0.017	0.020	0.32	0.43	0.52
b1	0.013	0.017	0.020	0.32	0.43	0.52
С	0.008	-	0.014	0.20	-	0.35
D	0.197	0.203	0.209	5.00	5.15	5.30
D1	0.189	0.193	0.197	4.80	4.90	5.00
D2	0.154	0.161	0.169	3.90	4.10	4.30
(d1)	-	0.016	-	-	0.40	-
(d2)	-	0.005	-	-	0.125	-
E	0.238	0.244	0.250	6.05	6.20	6.35
E1	0.228	0.232	0.236	5.80	5.90	6.00
E2	0.157	0.165	0.173	4.00	4.20	4.40
(E3)	-	0.144	-	-	3.65	-
е		0.050 BSC			1.27 BSC	
(K)	0.039	-	-	1.00	-	-
L1	0.019	-	0.043	0.48	-	1.10
L2	0.012	-	0.031	0.30	-	0.80
М	0.128	0.138	0.148	3.25	3.50	3.75
Θ	0°	-	10°	0°	-	10°

#### Notes

- Dimensioning and tolerancing per ASME Y14.5-2009
- Dimensions D1 and E1 do not include mold flash or gate burrs
- Dimension (XX) means reference only



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